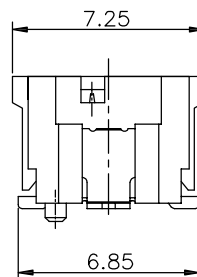
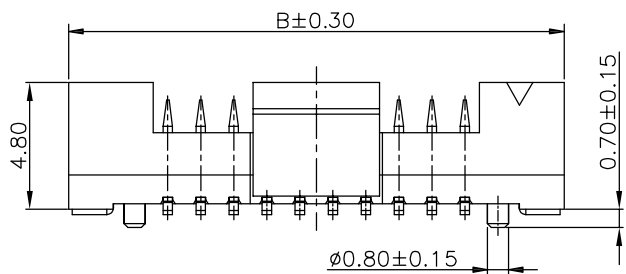
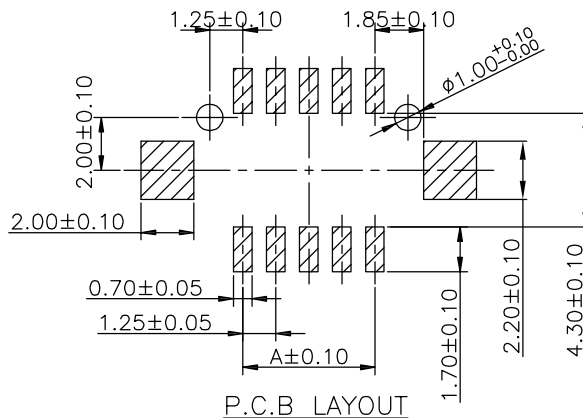
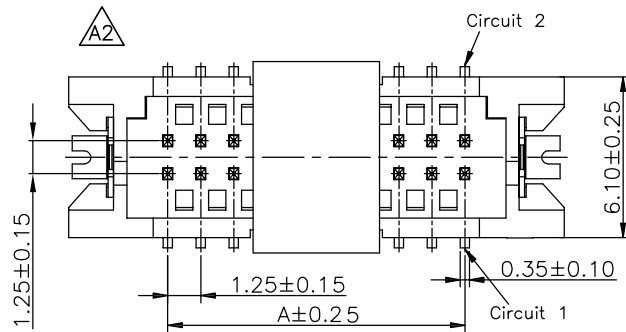


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements

RoHS



NOTE:

1.MATERIAL SPECIFICATION:

- 1-1.HOUSING: PA6T,UL94V-0
- 1-2.CONTACTS: BRASS
- 1-3.SOLDER TABS: BRASS

2.PLATING SPECIFICATION:

- 2-1.CONTACTS:GOLD FLASH OVER NICKEL
- 2-2.SOLDER TABS:GOLD FLASH OVER NICKEL

3.ELECTRICAL PERFORMANCE:

- 3-1.CURRENT RATING: 1A
- 3-2.CONTACT RESISTANCE: 30 mΩ MAX
- 3-3.INSULATION RESISTANCE: 500MΩ Min
- 3-4.DIELECTRIC WITHSTANDING : 500V

4.ENVIRONMENTAL PERFORMANCE:

- 4-1.OPERATING TEMPERATURE: -25°C~+85°C.

5.PACKAGE SPEC: REEL

6.P/N:

A1 A1252 W 0 2-2 XX 2 X X 0
SERIES NO: _____
CONNECTOR: _____
W-WAFER
ANGLE: _____
0-180°
TYPE: _____
2-TYPE 2
ROW NO: _____
2-DOUBLE ROW
COLOR: _____
A-BLACK
S-NATURE
PLATING: _____
1-G/F
A-ALL AU G/F
C-BRIGHE TIN
TERMIPOINT: _____
2-SMT
PIN Q'PY: _____
10~40

Circuit	Dimensions(mm)	
	A	B
2*02	1.25	8.75
2*05	5.00	12.50
2*06	6.25	13.75
2*07	7.50	15.00
2*10	11.25	18.75
2*15	17.50	25.00
2*20	23.75	31.25

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: A1252W02-2XX2XX0	DWG.NO: ENDE05	
				LINEAR	ANGLES						
A0	NEW RELEASE	21.01.13		0.0±0.35	X'REF±6°	APPROVED	Wang_jr	23.12.14	Pitch 1.25mm 180° 双排立贴带柱带附盖Wafer		REV: A2 SHEET: 1/1
A1	PART NUMBER RENEWAL	23.10.10		0.00±0.25	X'±3°	DESIGNER	Wang_jr	23.12.14			
A2	MODIFIED IN KIND	23.12.14		0.000±0.10	X'X' ±2°	DRAWN	Wang_jr	23.12.14			
			UNIT:mm								
			SIZE: A4								